

2SD1249, 2SD1249A

Silicon NPN triple diffusion planar type

For low-frequency power amplification

■ Features

- High collector to base voltage V_{CBO}
- N type package enabling direct soldering of the radiating fin to the printed circuit board, etc. of small electronic equipment.

■ Absolute Maximum Ratings ($T_C=25^\circ\text{C}$)

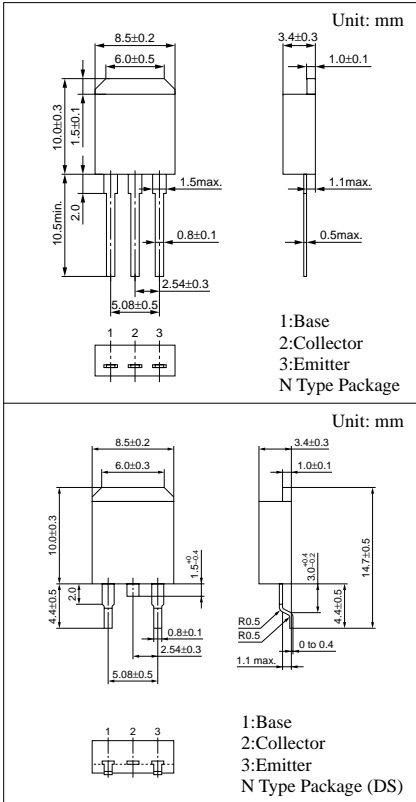
Parameter	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	350	V
Collector to emitter voltage	V_{CEO}	250	V
Emitter to base voltage	V_{EBO}	5	V
Peak collector current	I_{CP}	1.5	A
Collector current	I_C	0.75	A
Collector power dissipation	P_C	35	W
Junction temperature	T_j	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$

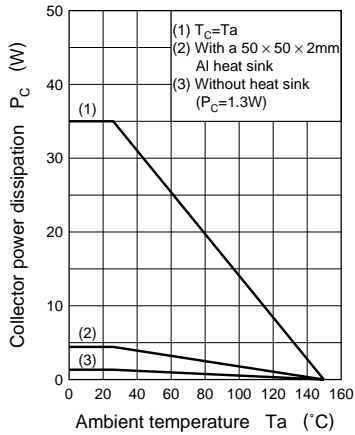
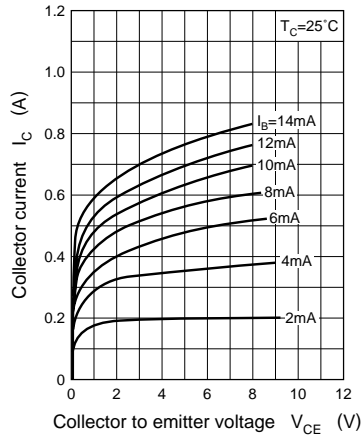
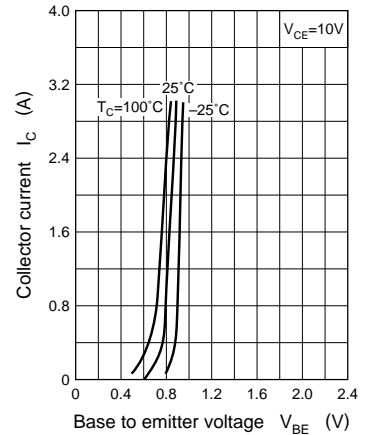
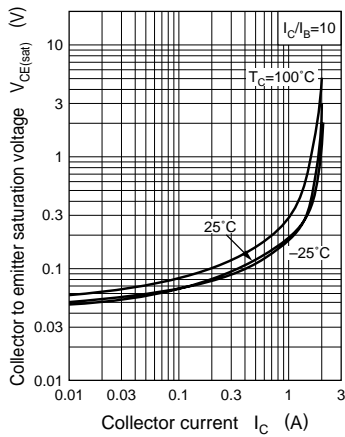
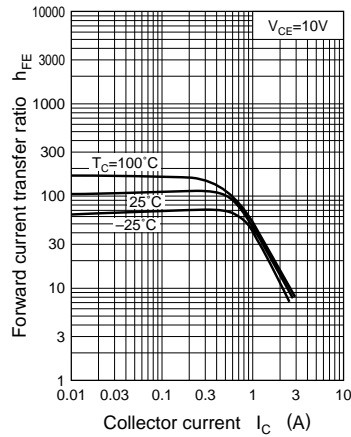
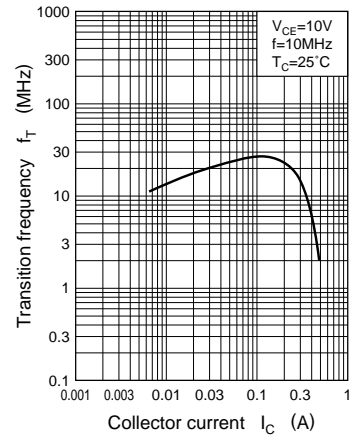
■ Electrical Characteristics ($T_C=25^\circ\text{C}$)

Parameter	Symbol	Conditions	min	typ	max	Unit
Collector cutoff current	I_{CES}	$V_{CE} = 350\text{V}, V_{BE} = 0$			1	mA
Collector cutoff current	I_{CEO}	$V_{CE} = 400\text{V}, V_{BE} = 0$			1	mA
Collector cutoff current	I_{CEO}	$V_{CE} = 150\text{V}, I_B = 0$			1	mA
Collector cutoff current	I_{CEO}	$V_{CE} = 200\text{V}, I_B = 0$			1	mA
Emitter cutoff current	I_{EBO}	$V_{EB} = 5\text{V}, I_C = 0$			1	mA
Collector to emitter voltage	V_{CEO}	$I_C = 30\text{mA}, I_B = 0$	250			V
Forward current transfer ratio	h_{FE1}^*	$V_{CE} = 10\text{V}, I_C = 0.3\text{A}$	40		250	
Forward current transfer ratio	h_{FE2}	$V_{CE} = 10\text{V}, I_C = 1\text{A}$	10			
Base to emitter voltage	V_{BE}	$V_{CE} = 10\text{V}, I_C = 1\text{A}$			1.5	V
Collector to emitter saturation voltage	$V_{CE(sat)}$	$I_C = 1\text{A}, I_B = 0.2\text{A}$			1	V
Transition frequency	f_T	$V_{CE} = 10\text{V}, I_C = 0.2\text{A}, f = 10\text{MHz}$		30		MHz
Turn-on time	t_{on}	$I_C = 1\text{A}, I_{B1} = 0.1\text{A}, I_{B2} = -0.1\text{A}, V_{CC} = 50\text{V}$		0.5		μs
Storage time	t_{stg}			2		μs
Fall time	t_f			0.5		μs

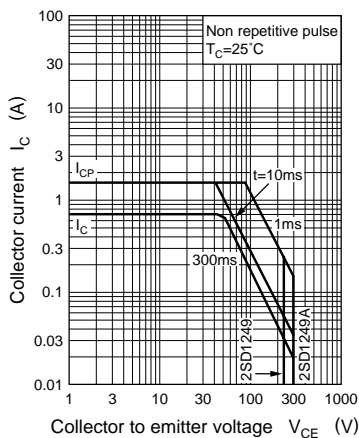
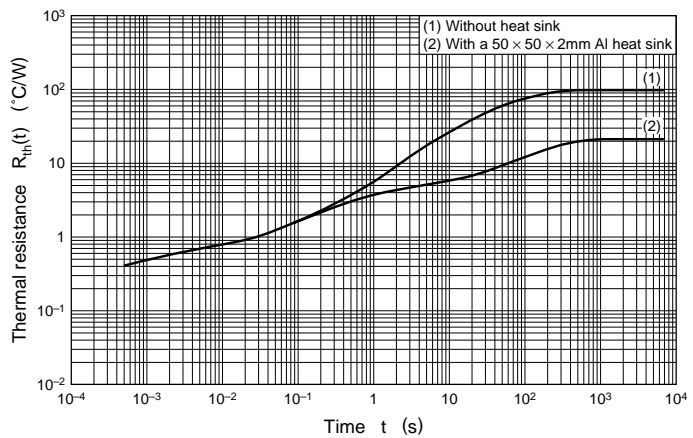
* h_{FE1} Rank classification

Rank	R	Q	P
h_{FE1}	40 to 90	70 to 150	120 to 250



$P_C - T_a$  $I_C - V_{CE}$  $I_C - V_{BE}$  $V_{CE(sat)} - I_C$  $h_{FE} - I_C$  $f_T - I_C$ 

Area of safe operation (ASO)

 $R_{th(t)} - t$ 

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